

DCR1020SF

DS4245-5.0 July 2001

Phase Control Thyristor

Replaces January 2000 version, DS4245-4.0

FEATURES

- Double Side Cooling
- High Surge Capability

APPLICATIONS

- High Power Drives
- High Voltage Power Supplies
- DC Motor Control
- Welding
- Battery Chargers

Type Number

DCR1020SF65

DCR1020SF64

DCR1020SF63

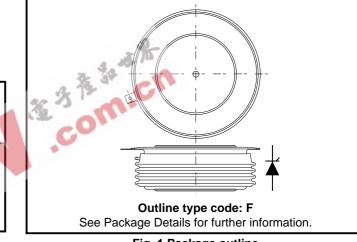
DCR1020SF62

DCR1020SF61

DCR1020SF60

VOLTAGE RATINGS

KEY	PARAMETERS
\mathbf{V}_{drm}	6500V
I _{t(av)}	640A
I _{tsm}	10700A
dVdt	1000V/ μs
dl/dt	100Α/ μs



Lower voltage grades available.

ORDERING INFORMATION

When ordering, select the required part number shown in the Voltage Ratings selection table.

Repetitive Peak

Voltages V_{DRM}V_{RRM} V

6500

6400

6300

6200

6100

6000

Conditions

 $T_{vi} = 0^{\circ} \text{ to } 125^{\circ}\text{C},$

V_{DRM} & V_{RRM} respectively

 $= I_{RRM} = 150 mA,$

+ 100V

 $V_{\text{DRM}}, V_{\text{RRM}} t_{\text{p}} = 10 \text{ms},$ $V_{\text{DSM}} \& V_{\text{RSM}} =$

For example:

DCR1020SF63

Note: Please use the complete part number when ordering and quote this number in any future correspondance relating to your order.





CURRENT RATINGS

T_{case} = 60°C unless stated otherwise.

Symbol	Parameter	Conditions	Max.	Units		
Double Side Cooled						
I _{T(AV)}	Mean on-state current	Half wave resistive load	640	A		
I _{T(RMS)}	RMS value	-	1005	А		
Ι _τ	Continuous (direct) on-state current	-	967	A		
Single Side Cooled (Anode side)						
I _{T(AV)}	Mean on-state current	Half wave resistive load	473	А		
I _{T(RMS)}	RMS value	-	742	A		
Ι _τ	Continuous (direct) on-state current		682	A		

CURRENT RATINGS

Ι _τ	Continuous (direct) on-state current	- 0	682	A	
	RATINGS unless stated otherwise.	Conditions			
Symbol	Parameter	Conditions	Max.	Units	
Double Side Cooled					
I _{T(AV)}	Mean on-state current	Half wave resistive load	515	А	
I _{T(RMS)}	RMS value	-		A	
Ι _τ	Continuous (direct) on-state current	-	765	A	
Single Side	e Cooled (Anode side)				
I _{T(AV)}	Mean on-state current	Half wave resistive load	377	A	
I _{T(RMS)}	RMS value	-	592	A	
Ι _τ	Continuous (direct) on-state current	-	530	A	



SURGE RATINGS

Symbol	Parameter	Conditions	Max.	Units
I _{TSM}	Surge (non-repetitive) on-state current	10ms half sine; T _{case} = 125°C	8.5	kA
l ² t	I ² t for fusing	$V_{R} = 50\% V_{RRM} - 1/4 \text{ sine}$	0.36 x 10 ⁶	A²s
I _{TSM}	Surge (non-repetitive) on-state current	10ms half sine; T _{case} = 125°C	10.7	kA
l²t	I ² t for fusing	V _R = 0	0.562 x 10 ⁶	A ² s

THERMAL AND MECHANICAL DATA

Symbol	Parameter	Conditions		Min.	Max.	Units
	Thermal resistance - junction to case	Double side cooled	dc	-	0.022	°C/W
R _{th(j-c)}		Single side cooled	Anode dc	-	0.038	°C/W
			Cathode dc	-	0.052	°C/W
R _{th(c-h)}	Thermal resistance - case to heatsink	Clamping force 19.5kN with mounting compound	Double side	-	0.004	°C/W
			Single side	-	0.008	°C/W
T _{vj}	Virtual junction temperature	On-state (conducting)		-	135	°C
		Reverse (blocking)		-	125	°C
T _{stg}	Storage temperature range			-55	125	°C
-	Clamping force			18.0	22.0	kN



DYNAMIC CHARACTERISTICS

Symbol	Parameter	Conditions		Тур.	Max.	Units
V _{TM}	Maximum on-state voltage	At 1800A peak, T _{case} = 25°C		-	3.6	V
I _{RRM} /I _{DRM}	Peak reverse and off-state current	At $V_{\text{RRM}}/V_{\text{DRM}}$, $T_{\text{case}} = 125^{\circ}\text{C}$		-	150	mA
dV/dt	Maximum linear rate of rise of off-state voltage	To 67% $V_{DRM} T_j = 125^{\circ}C.$		-	1000	V/µs
-11 / -14		From 67% V _{DRM} to 1000A	Repetitive 50Hz	-	30	A/μs
dl/dt	Rate of rise of on-state current	Gate source $30V$, 15Ω t, $\leq 0.5\mu$ s. T _j = 125°C.	Non-repetitive	-	100	A/μs
V _{T(TO)}	Threshold voltage	At $T_{vj} = 125^{\circ}C$		-	1.2	V
r _T	On-state slope resistance	At T _{vj} = 125°C		-	1.92	mΩ
t _{gd}	Delay time	$V_{\rm D}$ = 67% $V_{\rm DRM}$, Gate source 30V, 15Ω Rise time 0.5μs, T _j = 25°C		0.5	1.5	μs
t _q	Turn-off time	$I_{T} = 1000A, t_{p} = 1ms, T_{j} = 125^{\circ}C,$ $V_{RM} = 100V, dI_{RR}/dt = 10A/\mu s,$ $V_{DR} = 67\% V_{DRM}, dV_{DR}/dt = 25V/\mu s$		600	-	μs
I _L	Latching current	$T_{j} = 25^{\circ}C, V_{D} = 10V$		-	600	mA
I _H	Holding current	$T_i = 25^{\circ}C$		-	200	mA

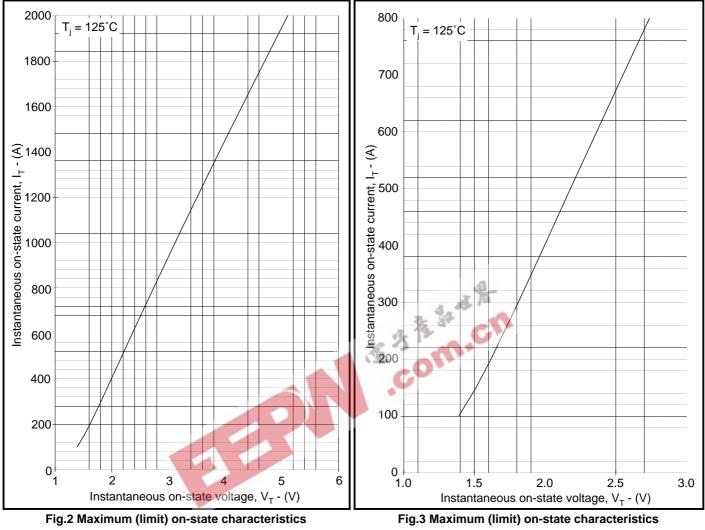
GATE TRIGGER CHARACTERISTICS AND RATINGS

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Symbol	Parameter	Conditions		Max.	Units
V _{GT}	Gate trigger voltage	$V_{\text{DRM}} = 5V, T_{\text{case}} = 25^{\circ}\text{C}$	-	3.0	V
I _{GT}	Gate trigger current	$V_{\text{DRM}} = 5V, T_{\text{case}} = 25^{\circ}\text{C}$	-	300	mA
V _{gd}	Gate non-trigger voltage	At $V_{DRM} T_{case} = 125^{\circ}C$	-	0.25	V
V _{FGM}	Peak forward gate voltage	Anode positive with respect to cathode	-	30	V
V_{FGN}	Peak forward gate voltage	Anode negative with respect to cathode	-	0.25	V
V _{rgm}	Peak reverse gate voltage		-	5	V
I _{FGM}	Peak forward gate current	Anode positive with respect to cathode	-	10	A
$P_{G(M)}$	Peak gate power	See Gate Characteristics curve/table	-	150	w
P _{G(AV)}	Mean gate power		-	5	w



CURVES



 V_{TM} Equation:-

$$V_{TM} = A + Bln (I_T) + C.I_T + D.\sqrt{I_T}$$

Where A = 0.25863

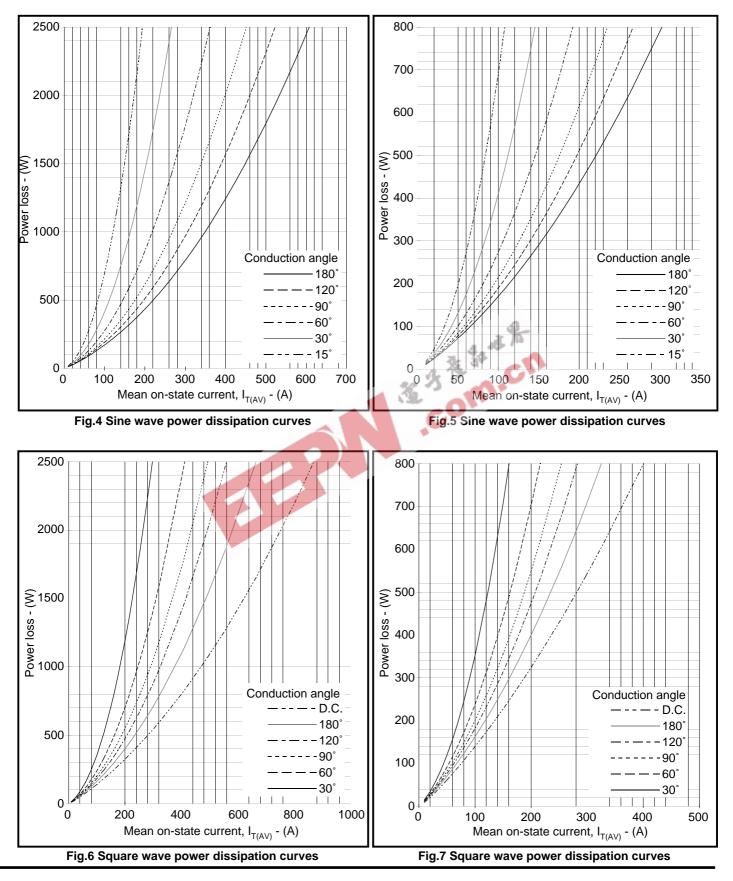
B = 0.322589

C = 0.002564

D = -0.061059

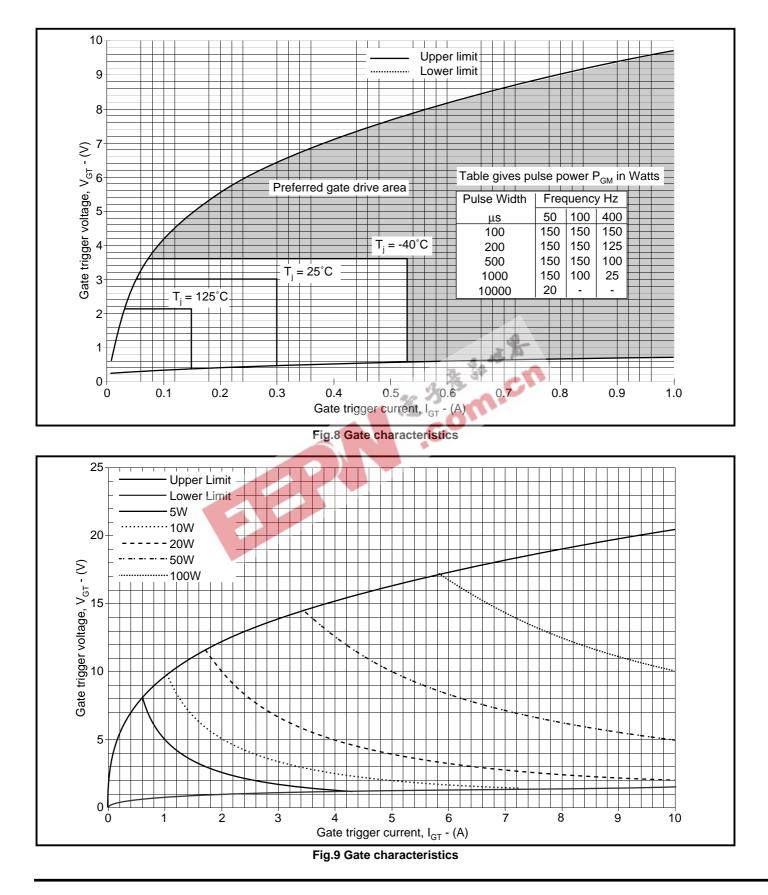
these values are valid for $T_i = 125^{\circ}C$ for $I_T 100A$ to 2000A



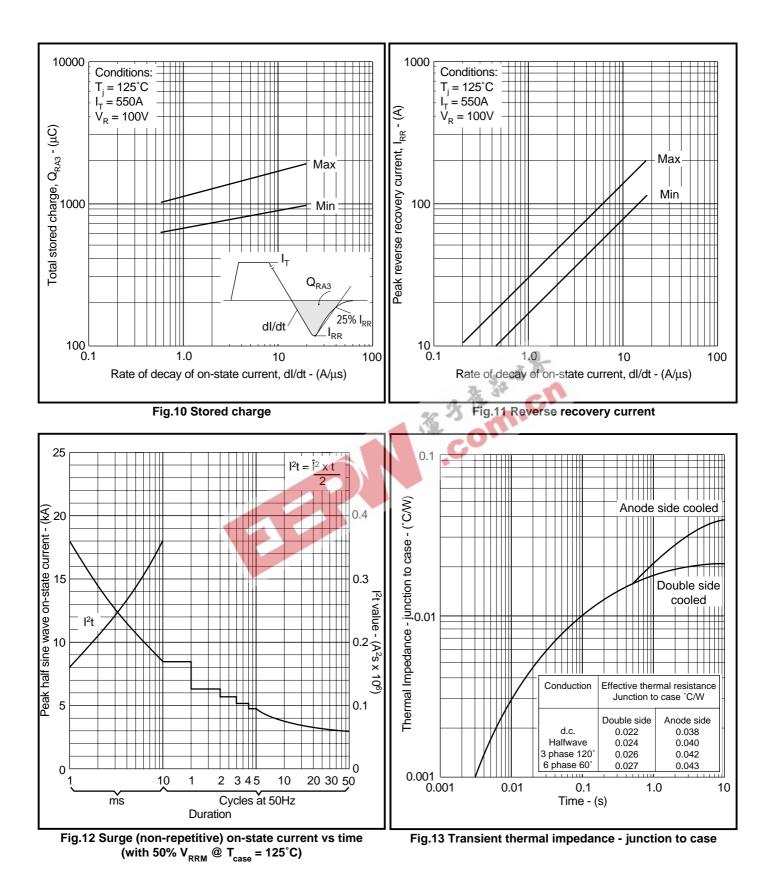








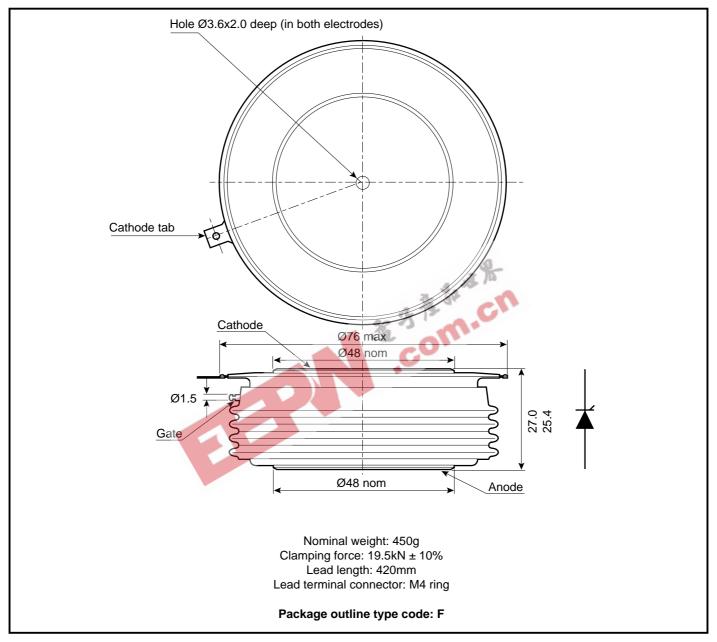






PACKAGE DETAILS

For further package information, please contact your nearest Customer Service Centre. All dimensions in mm, unless stated otherwise. DO NOT SCALE.





POWER ASSEMBLY CAPABILITY

The Power Assembly group was set up to provide a support service for those customers requiring more than the basic semiconductor, and has developed a flexible range of heatsink and clamping systems in line with advances in device voltages and current capability of our semiconductors.

We offer an extensive range of air and liquid cooled assemblies covering the full range of circuit designs in general use today. The Assembly group continues to offer high quality engineering support dedicated to designing new units to satisfy the growing needs of our customers.

Using the latest CAD methods our team of design and applications engineers aim to provide the Power Assembly Complete Solution (PACs).

DEVICE CLAMPS

Disc devices require the correct clamping force to ensure their safe operation. The PACS range includes a varied selection of pre-loaded clamps to suit all of our manufactured devices. Types available include cube clamps for single side cooling of 'T' 23mm and 'E' 30mm discs, and bar clamps right up to 83kN for our 'Z' 100mm thyristors and diodes.

Clamps are available for single or double side cooling, with high insulation versions for high voltage assemblies.

Please refer to our application note on device clamping, AN4839

HEATSINKS

The Power Assembly group has its own proprietary range of extruded aluminium heatsinks. They have been designed to optimise the performance of Dynex semiconductors. Data with respect to air natural, forced air and liquid cooling (with flow rates) is available on request.

For further information on device clamps, heatsinks and assemblies, please contact your nearest sales representative or customer service office.



HEADQUARTERS OPERATIONS **DYNEX SEMICONDUCTOR LTD** Doddington Road, Lincoln. Lincolnshire. LN6 3LF. United Kingdom. Tel: 00-44-(0)1522-500500 Fax: 00-44-(0)1522-500550

DYNEX POWER INC. 99 Bank Street, Suite 410, Ottawa, Ontario, Canada, K1P 6B9 Tel: 613.723.7035 Fax: 613.723.1518 Toll Free: 1.888.33.DYNEX (39639) http://www.dynexsemi.com

e-mail: power_solutions@dynexsemi.com

CUSTOMER SERVICE CENTRES Mainland Europe Tel: +33 (0)1 58 04 91 00. Fax: +33 (0)1 46 38 51 33 North America Tel: (613) 723-7035. Fax: (613) 723-1518. UK, Scandinavia & Rest Of World Tel: +44 (0)1522 500500. Fax: +44 (0)1522 500020

SALES OFFICES

Mainland Europe Tel: +33 (0)1 58 04 91 00. Fax: +33 (0)1 46 38 51 33 North America Tel: (613) 723-7035. Fax: (613) 723-1518. Toll Free: 1.888.33.DYNEX (39639) / Tel: (949) 733-3005. Fax: (949) 733-2986. UK, Scandinavia & Rest Of World Tel: +44 (0)1522 500500. Fax: +44 (0)1522 500020

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Target Information: This is the most tentative form of information and represents a very preliminary specification. No actual design work on the product has been started.

Preliminary Information: The product is in design and development. The datasheet represents the product as it is understood but details may change.

Advance Information: The product design is complete and final characterisation for volume production is well in hand.

No Annotation: The product parameters are fixed and the product is available to datasheet specification.

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